









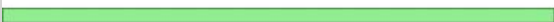


Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.018mm	
5		Dielectric 1	FR-4	0.127mm	4.2
6		Ground Plane	Copper	0.035mm	
7		Dielectric 3	FR-4	0.254mm	4.2
8		Power Plane	Copper	0.035mm	
9		Dielectric 4	FR-4	0.127mm	4.2
10		Bottom Layer	Copper	0.018mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 0.634mm				